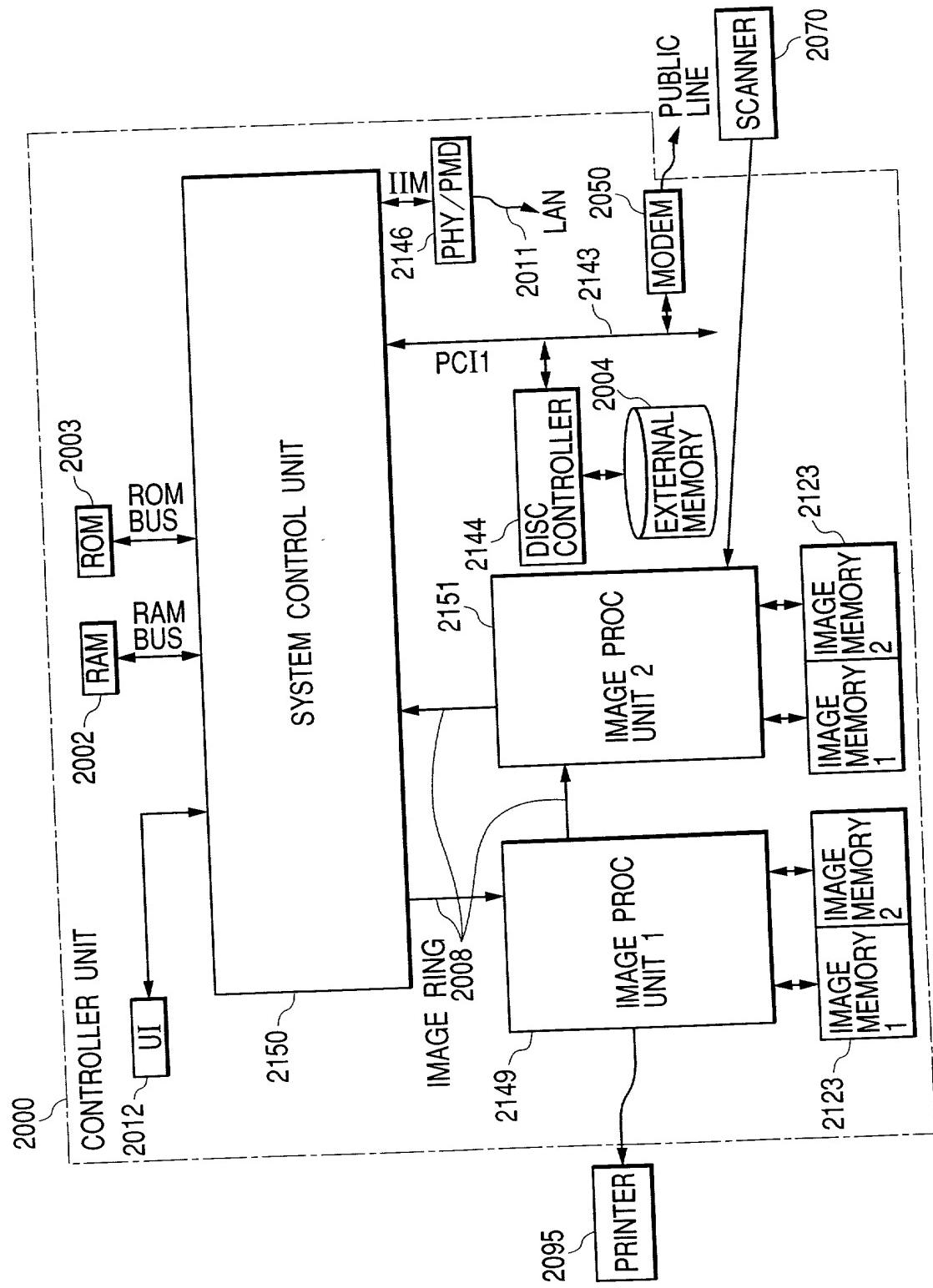


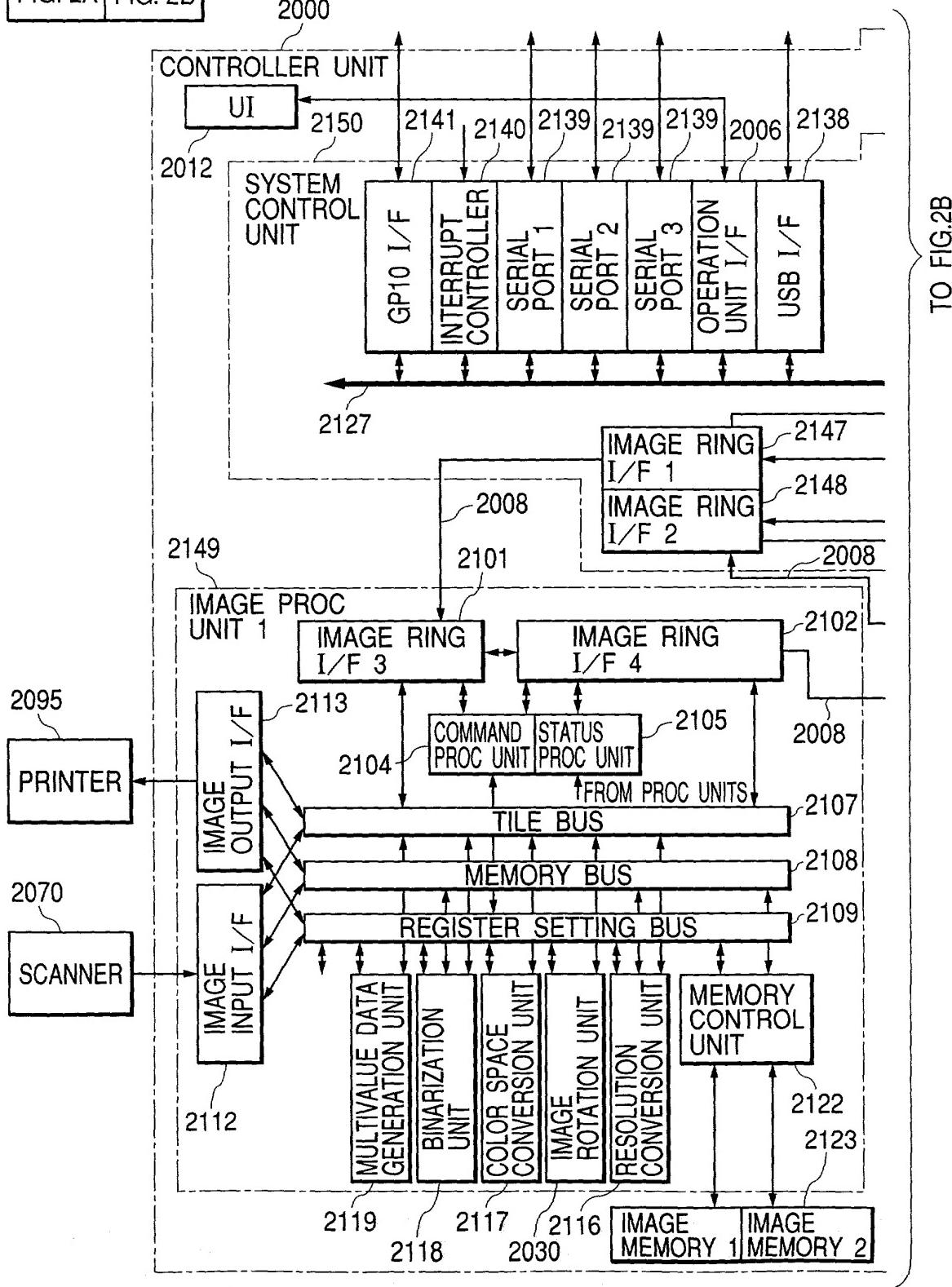
*FIG. 1*

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**FIG. 2****FIG. 2A**

FIG. 2A | FIG. 2B



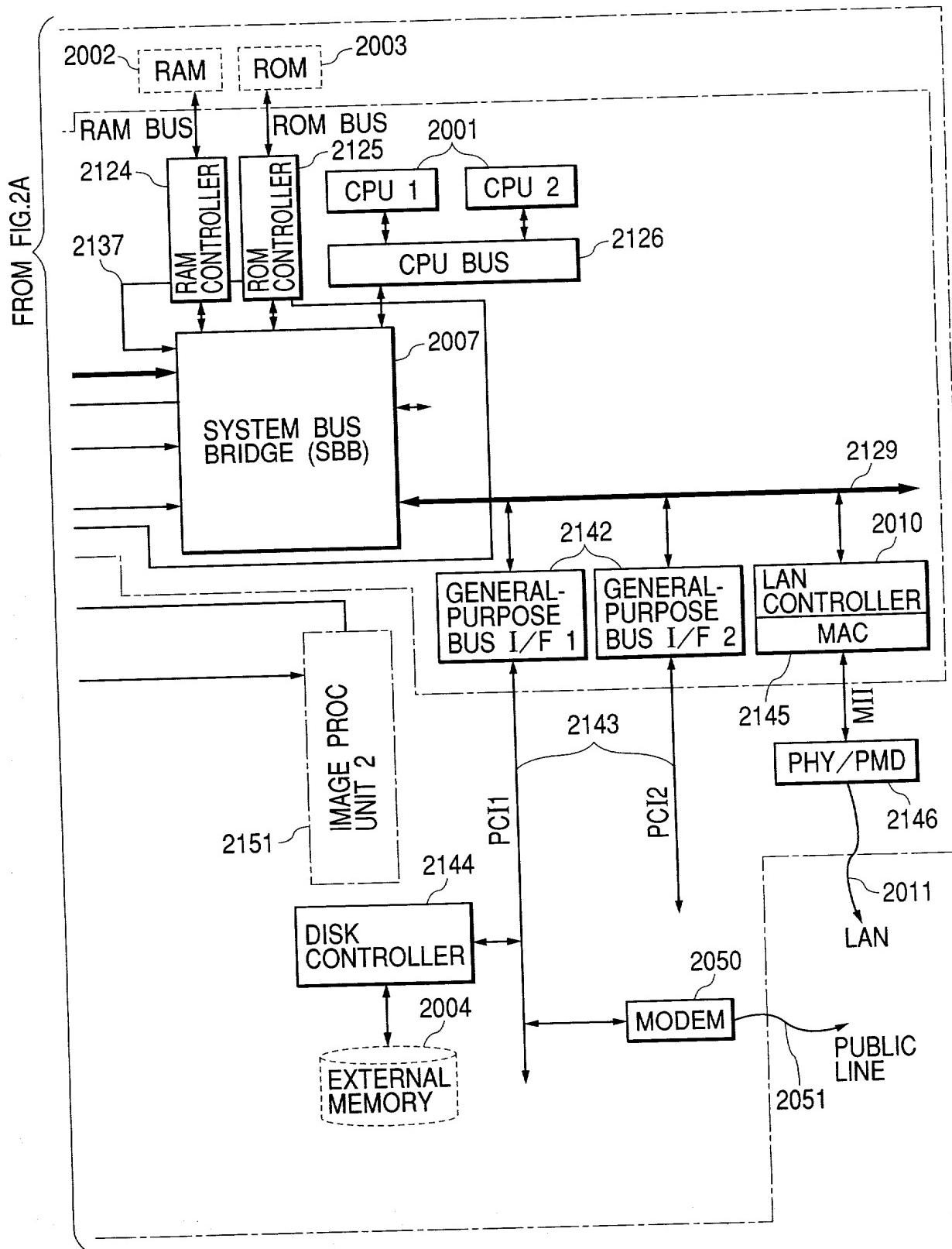
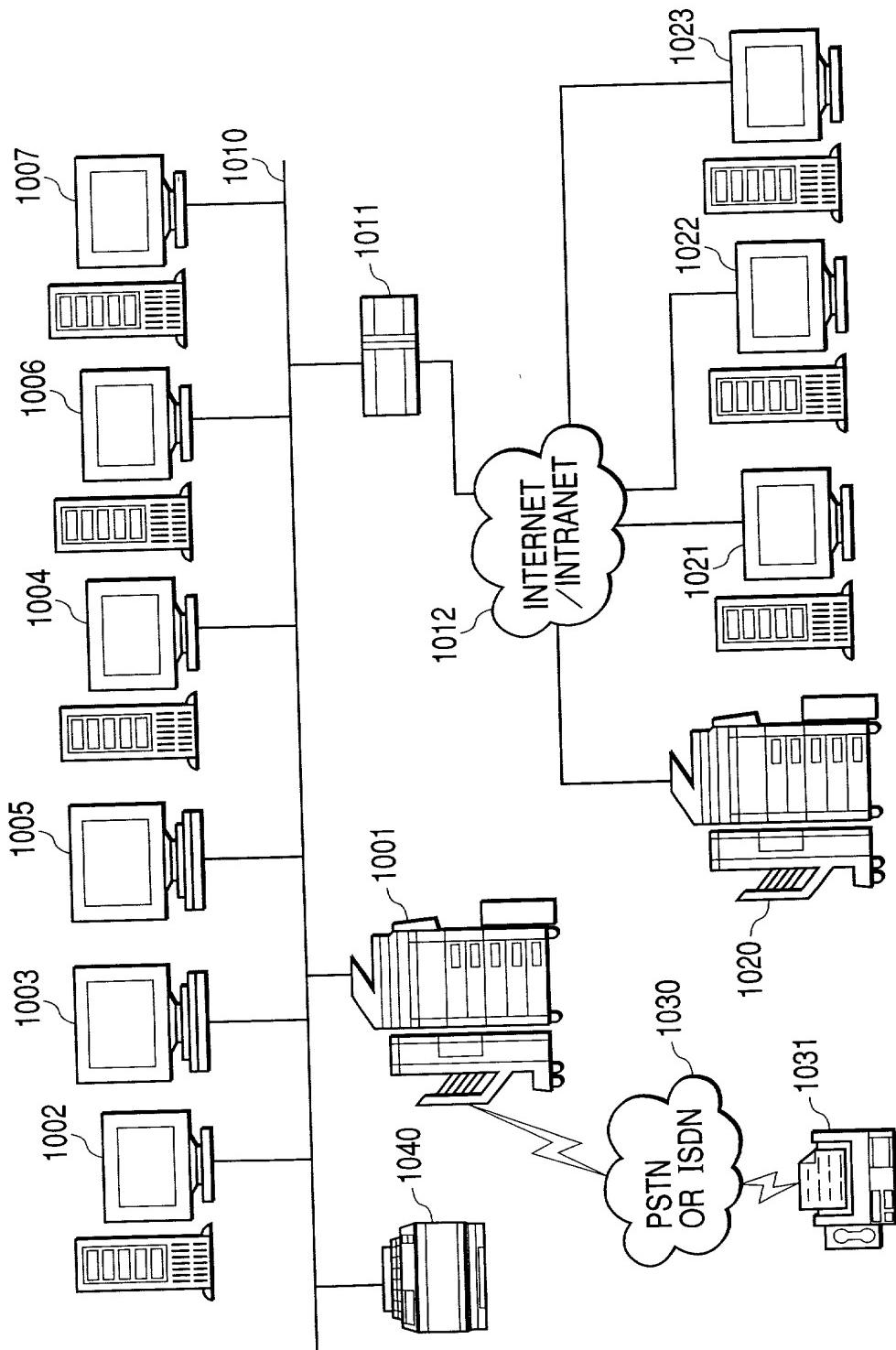
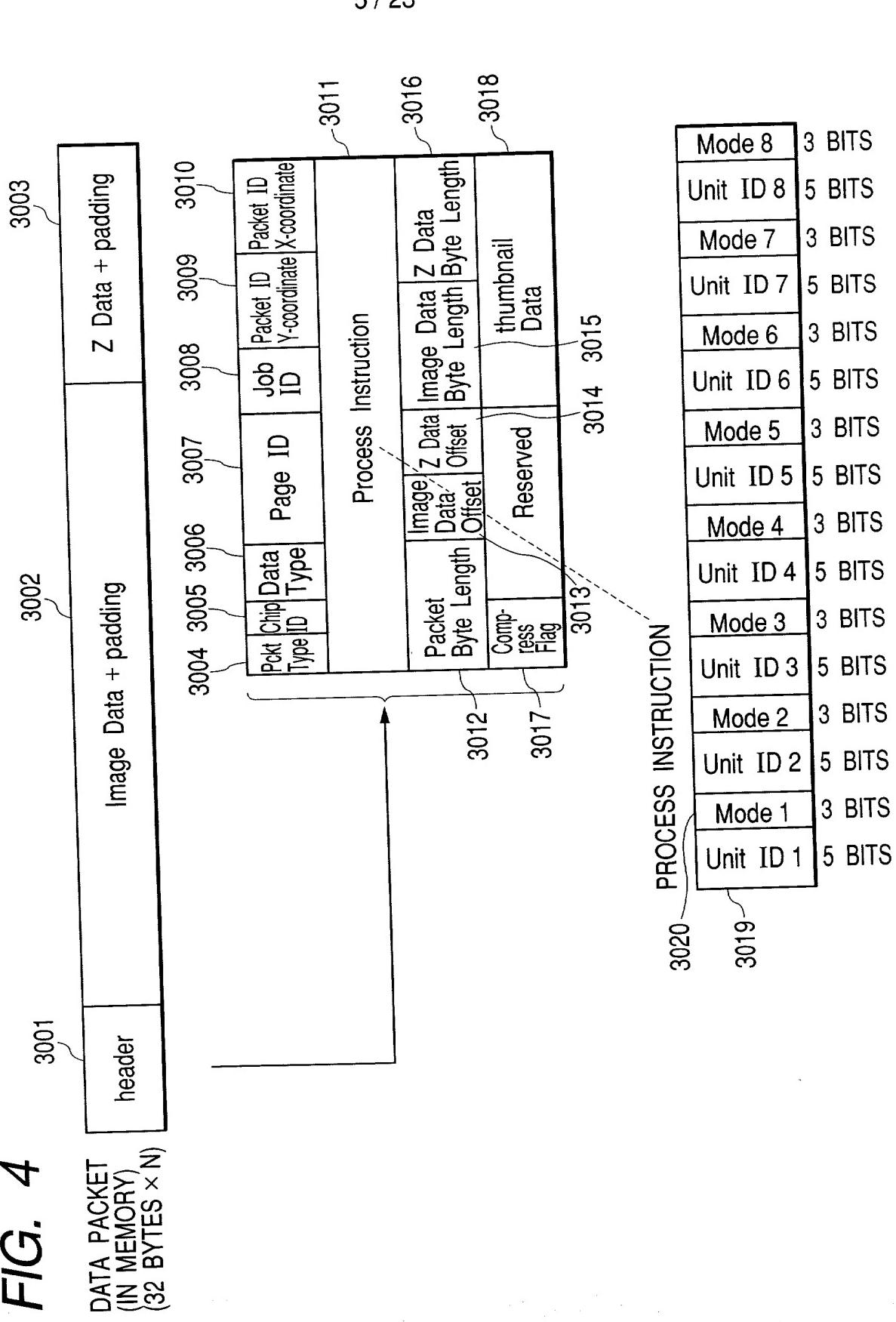
**FIG. 2B**

FIG. 3

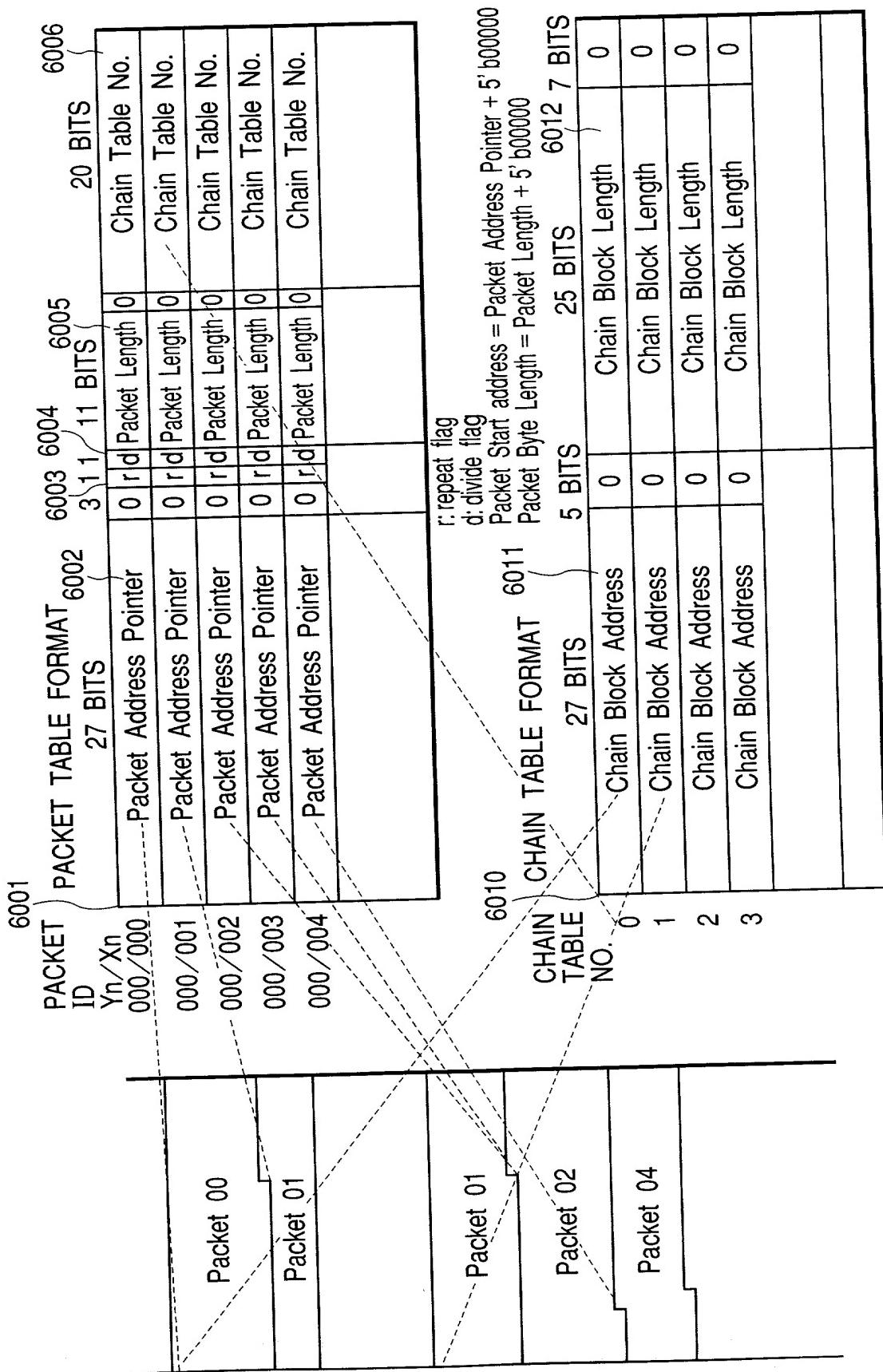


**FIG. 4**



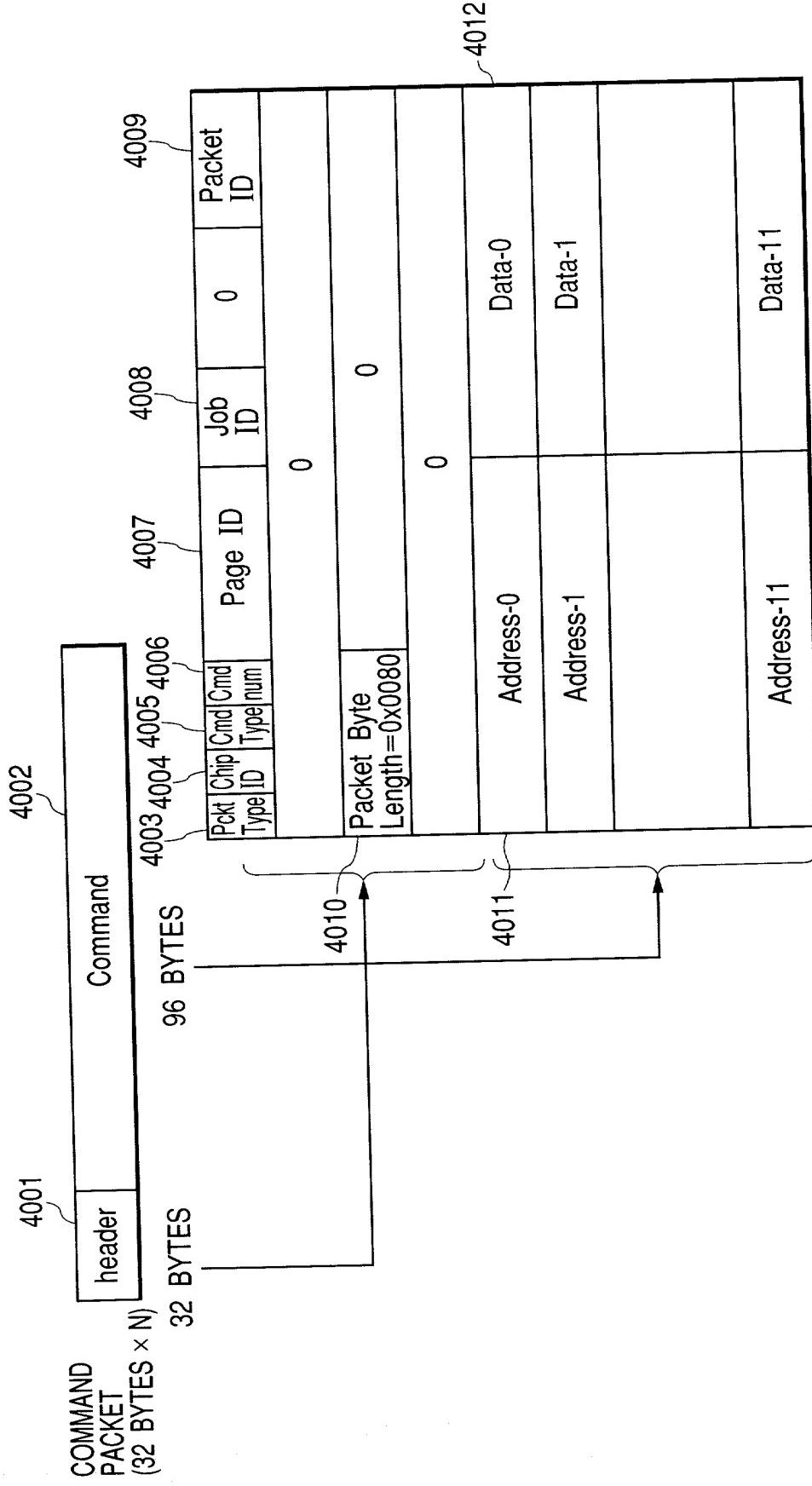
**FIG. 5**

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**FIG. 6**

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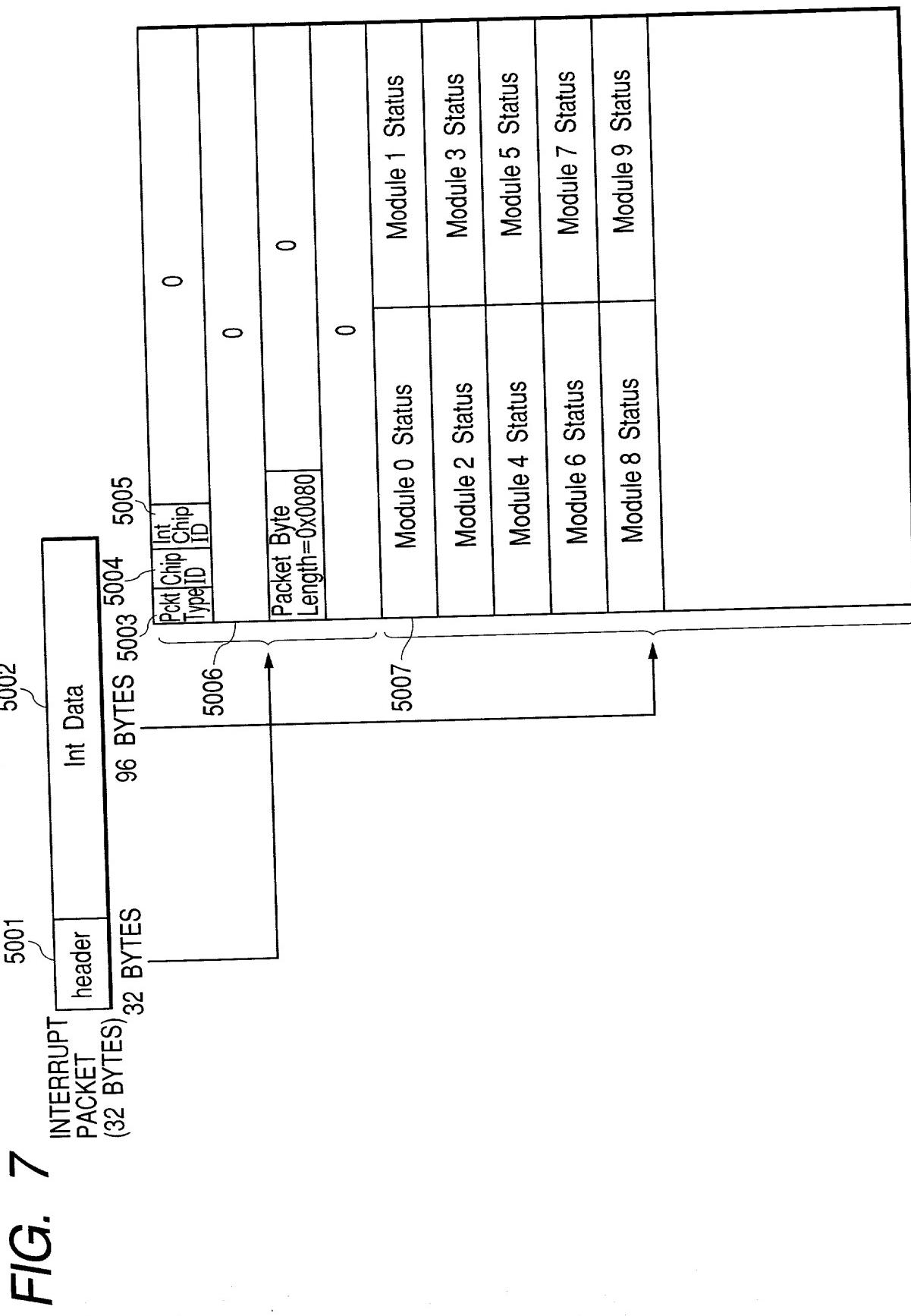


FIG. 8

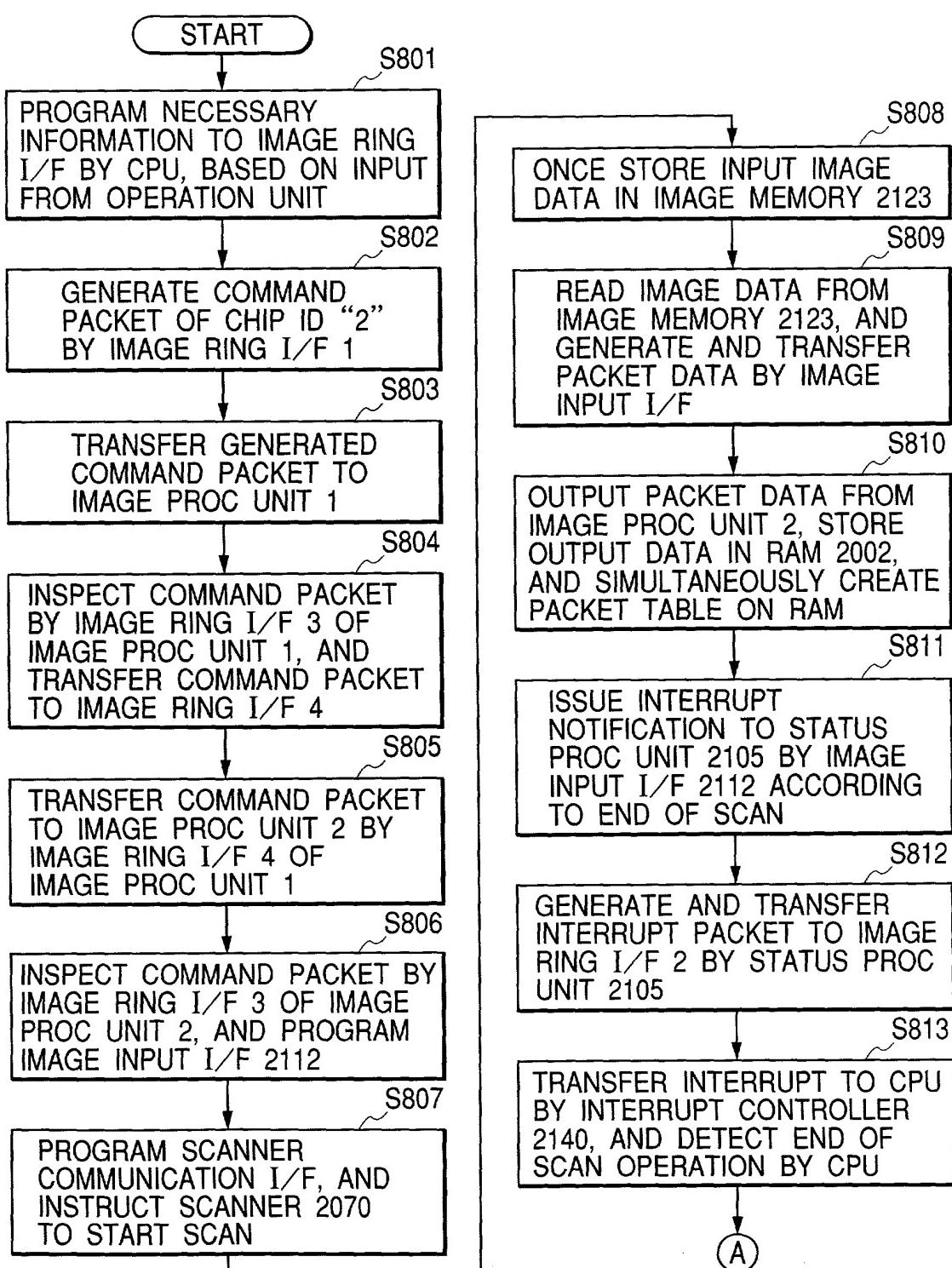
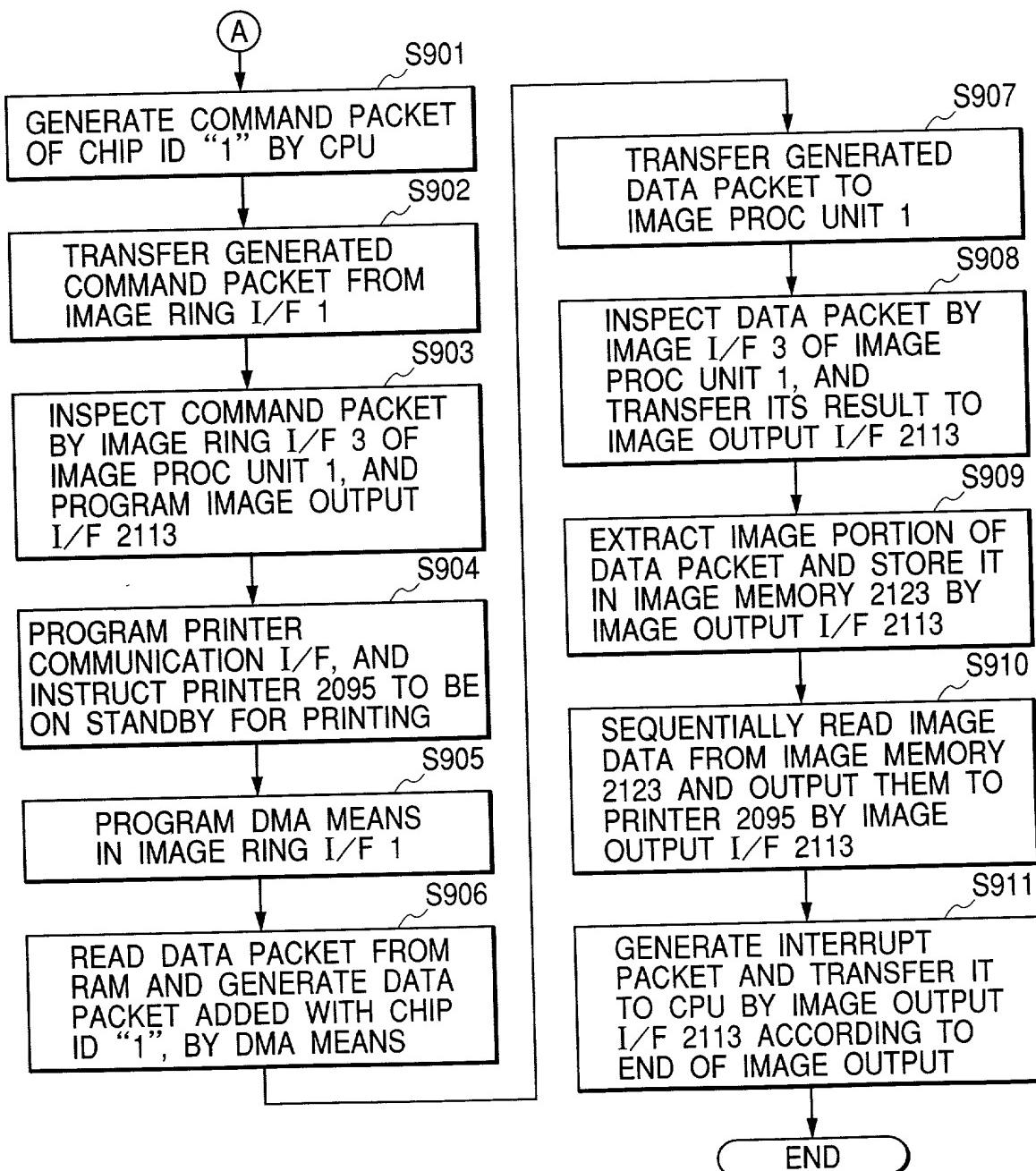


FIG. 9

PROPOSED PROCESS



**FIG. 10**

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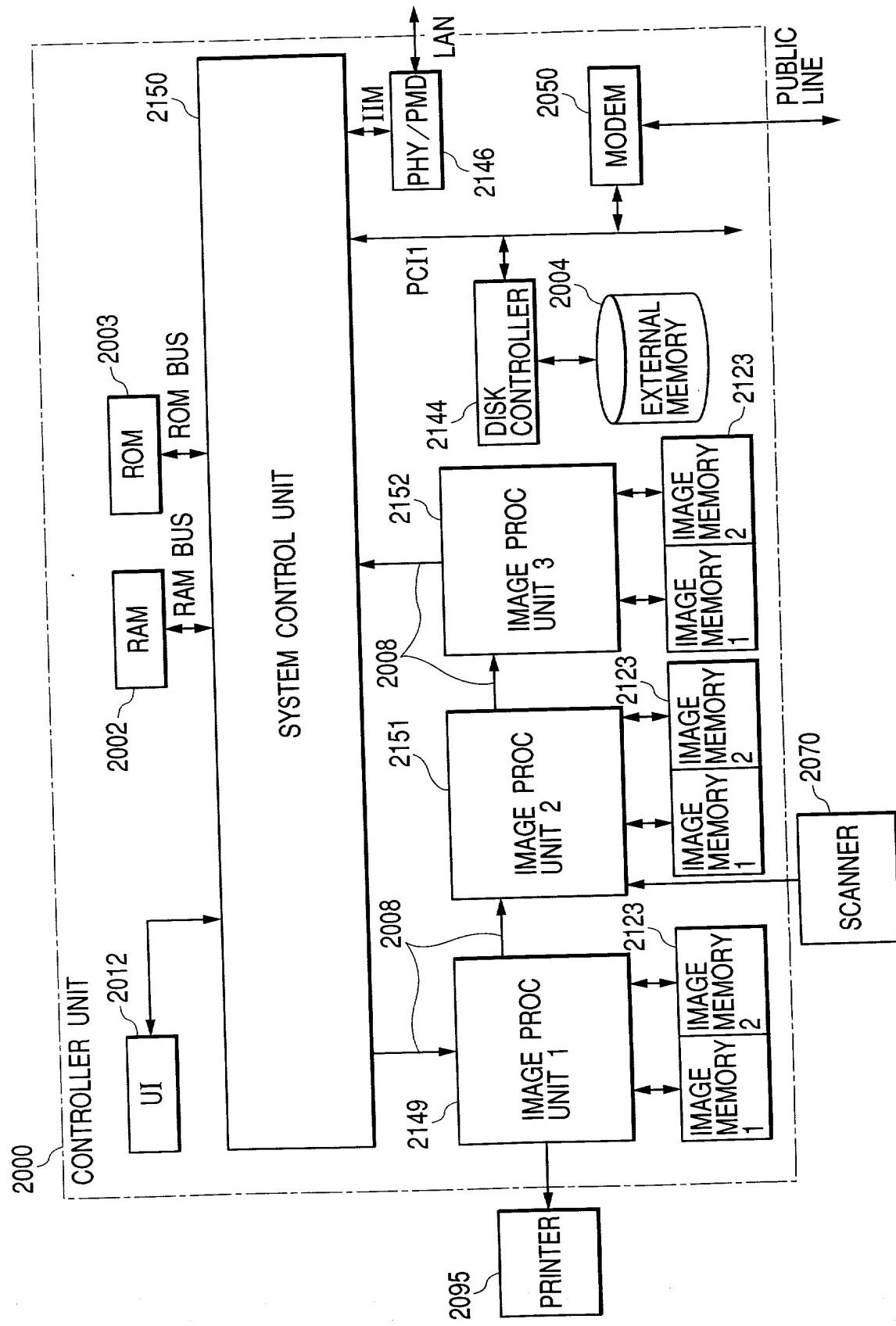


FIG. 11

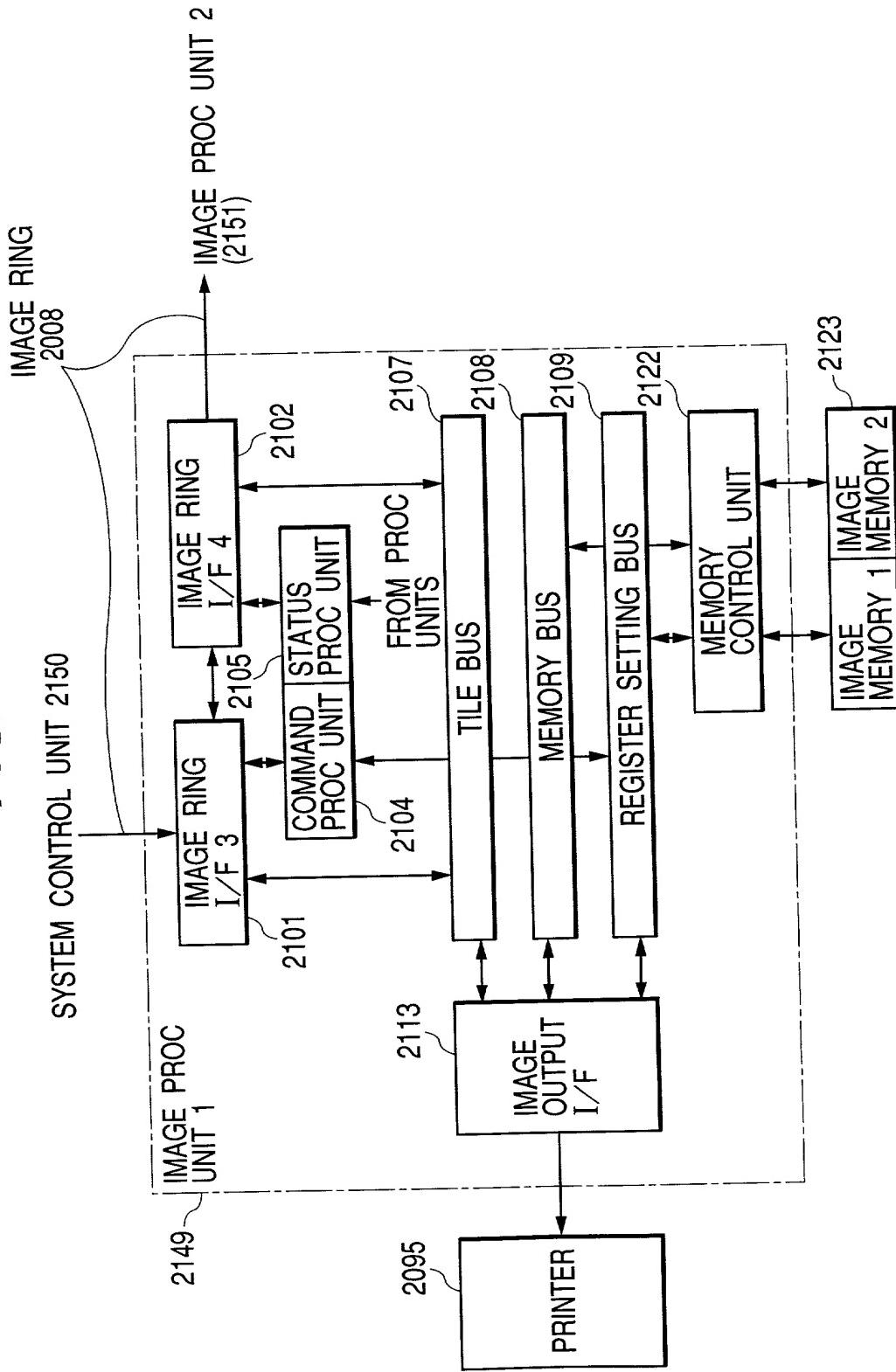


FIG. 12

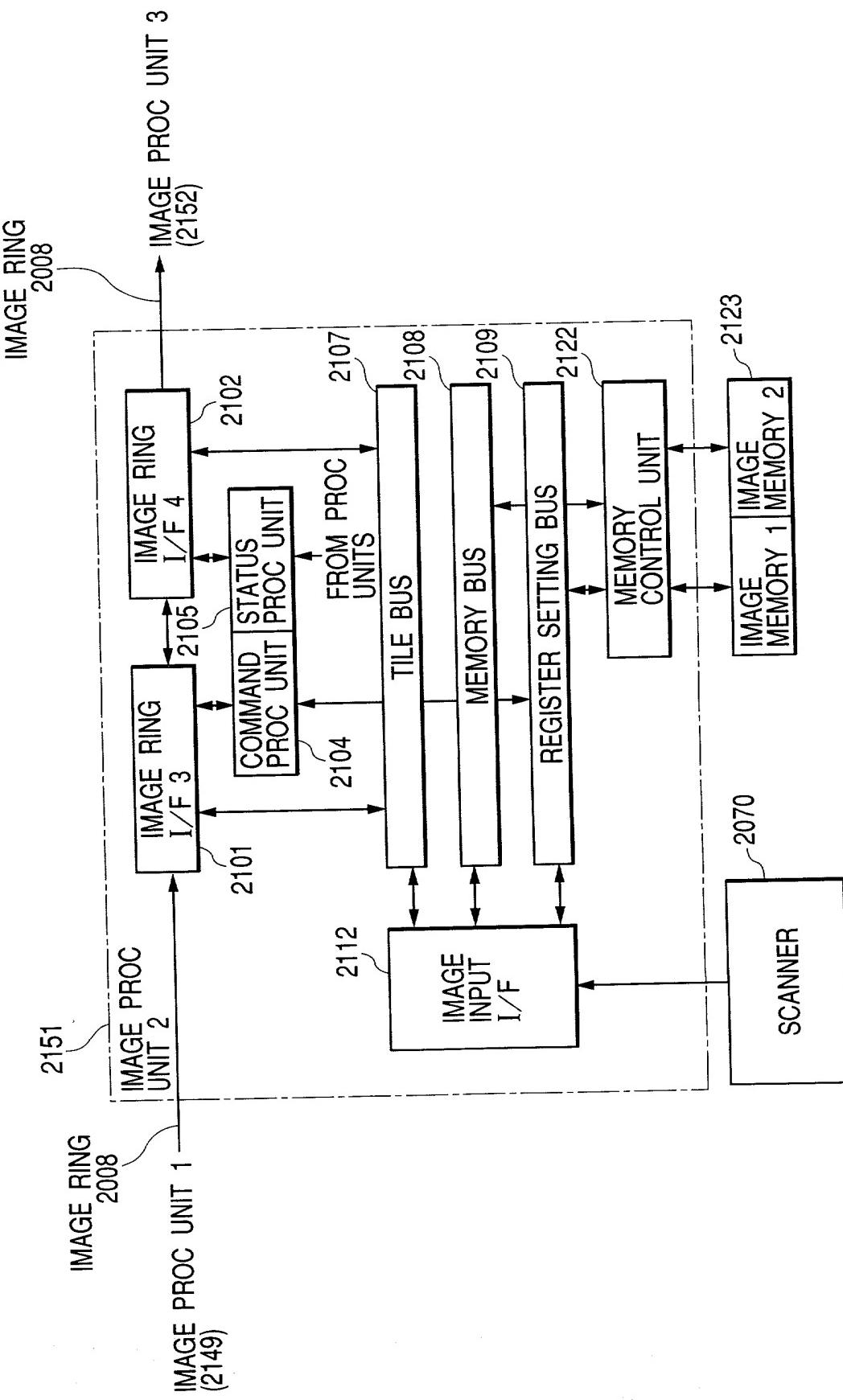


FIG. 13

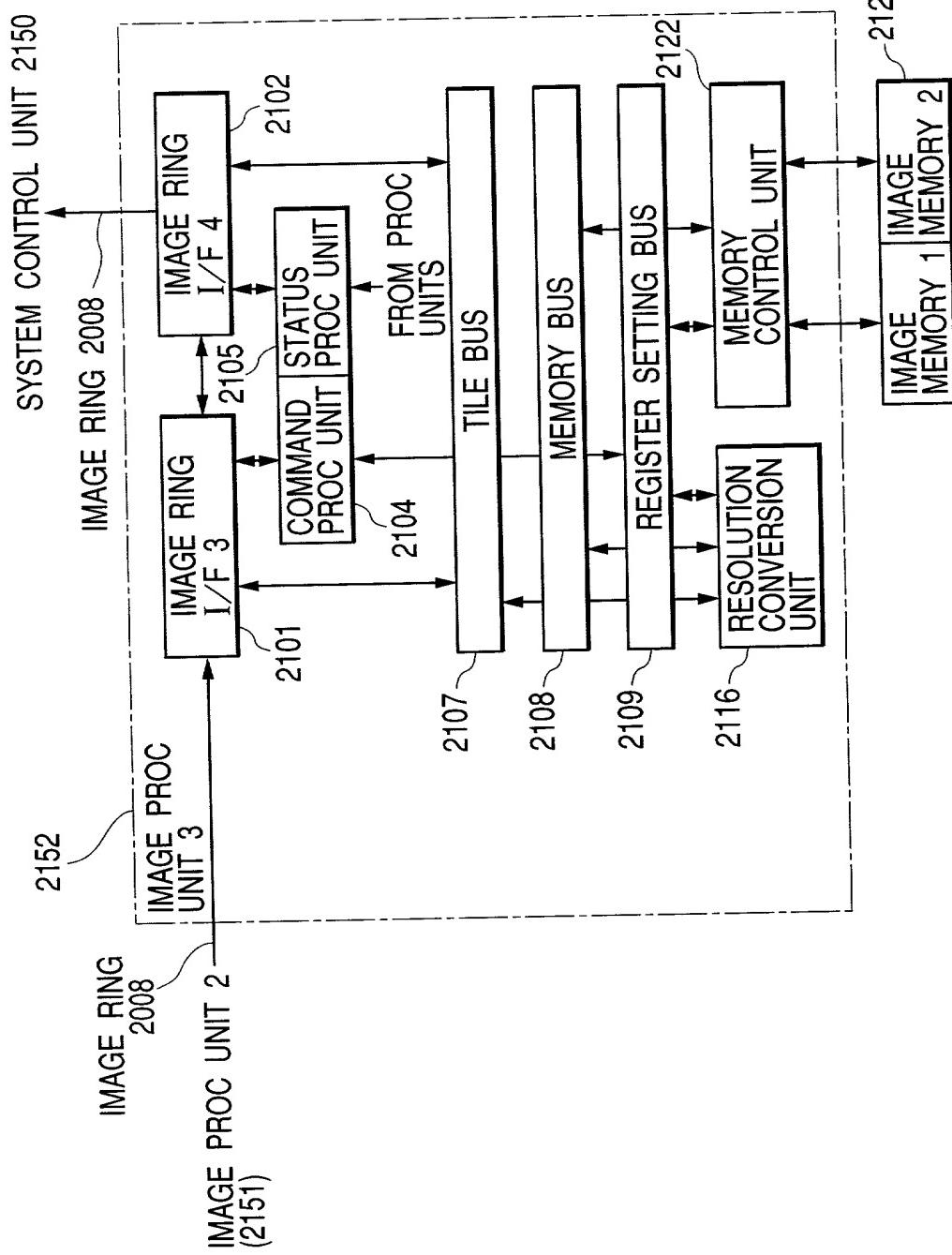


FIG. 14

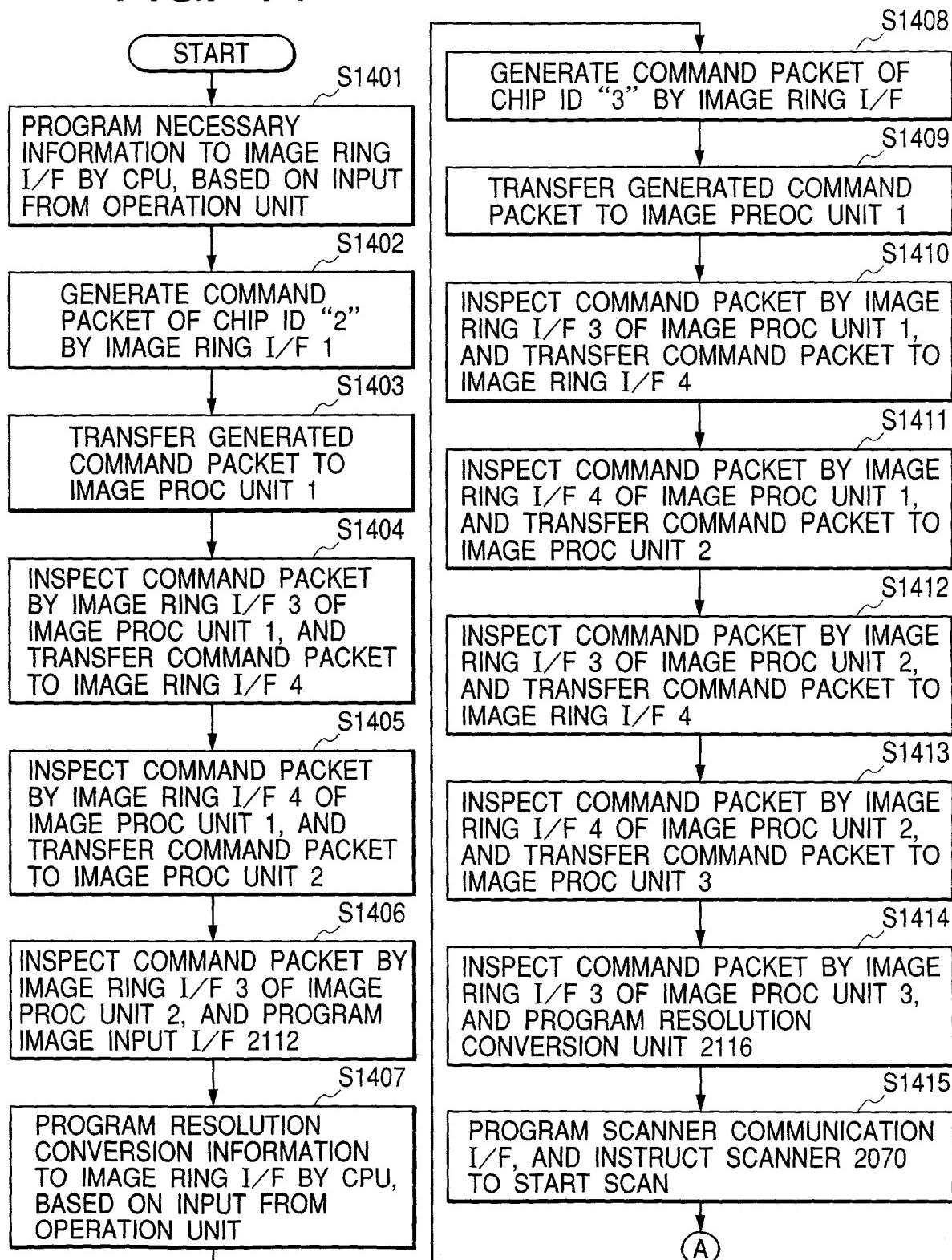


FIG. 15

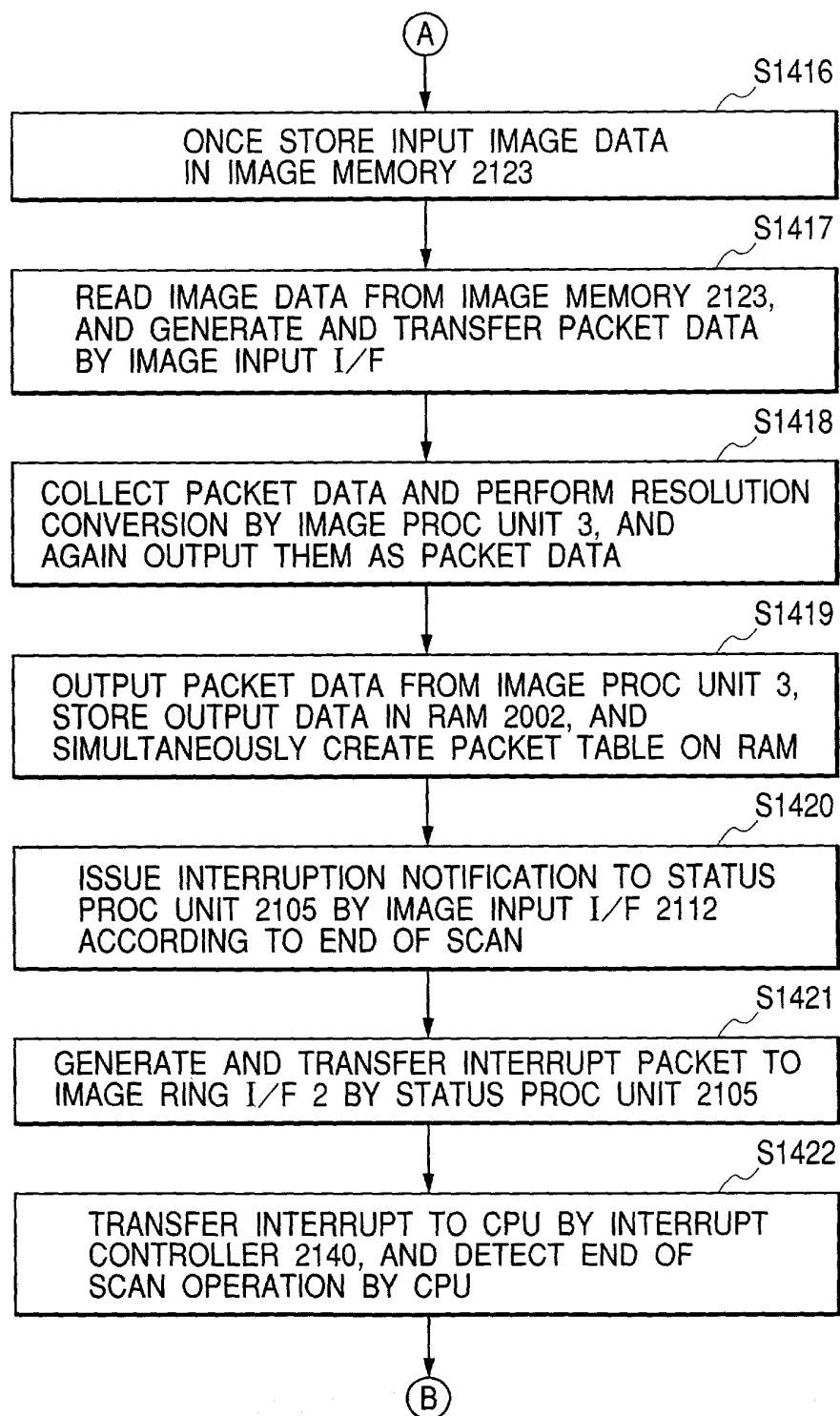
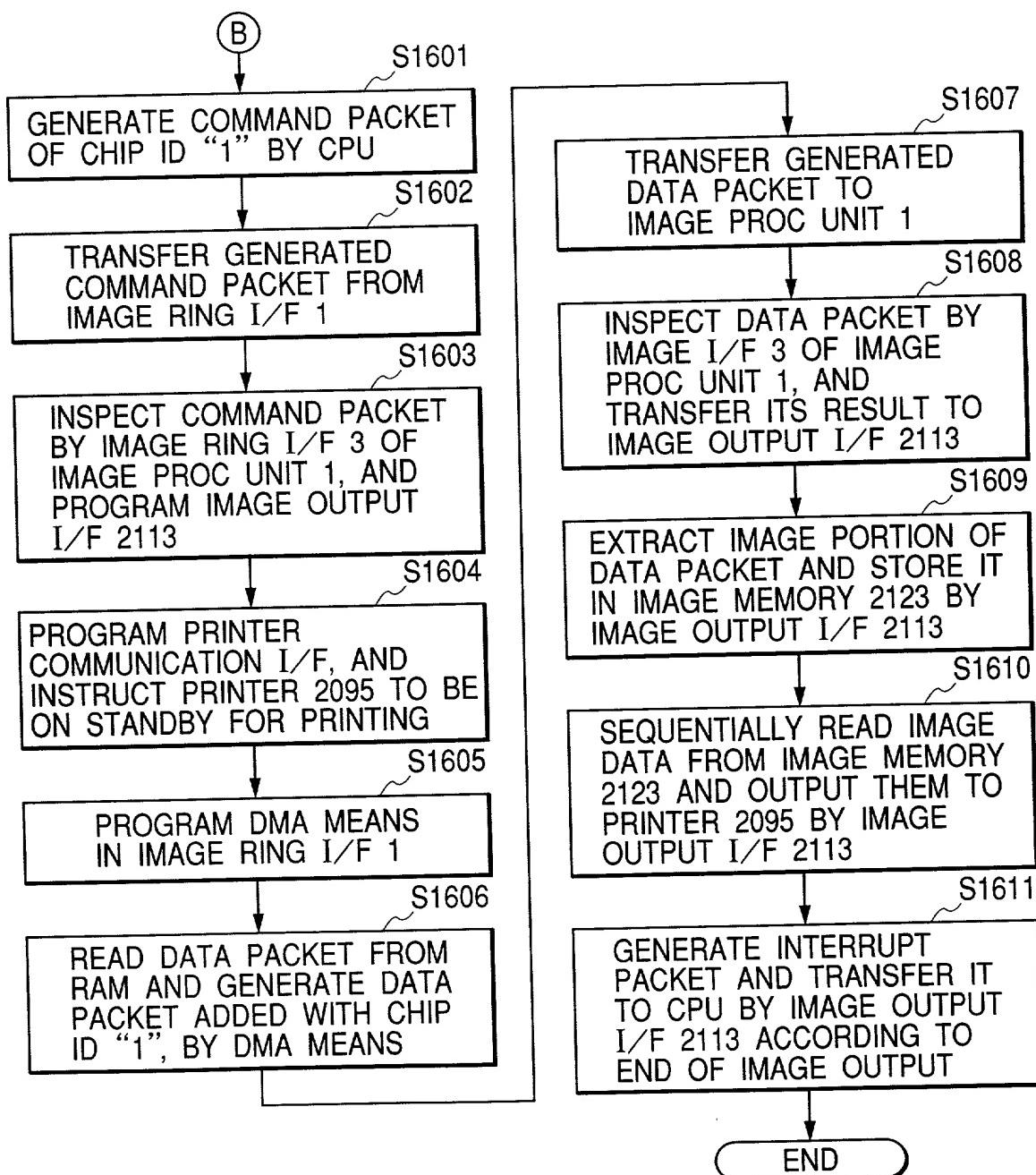


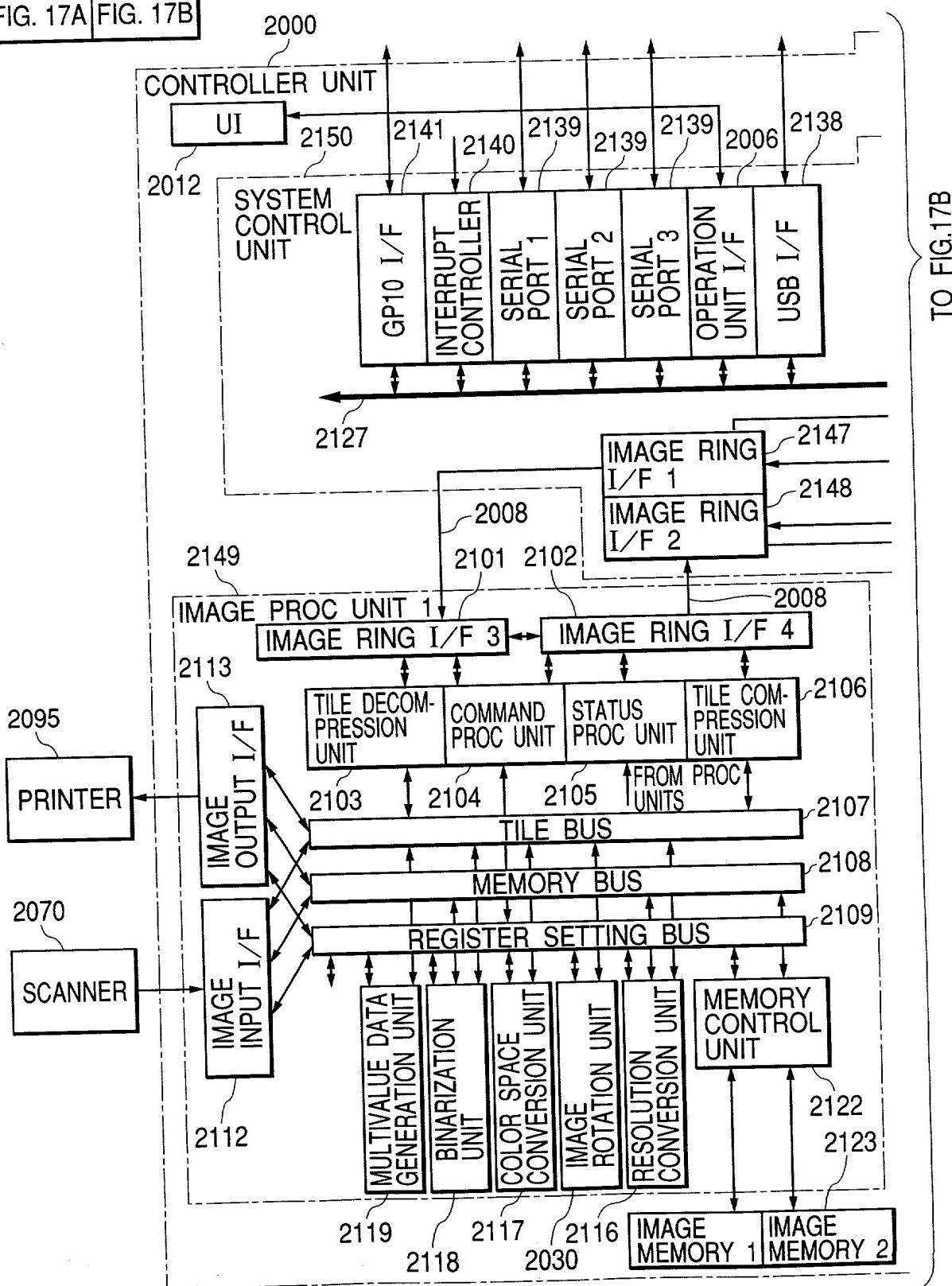
FIG. 16

TOP SECRET//DTI//COMINT

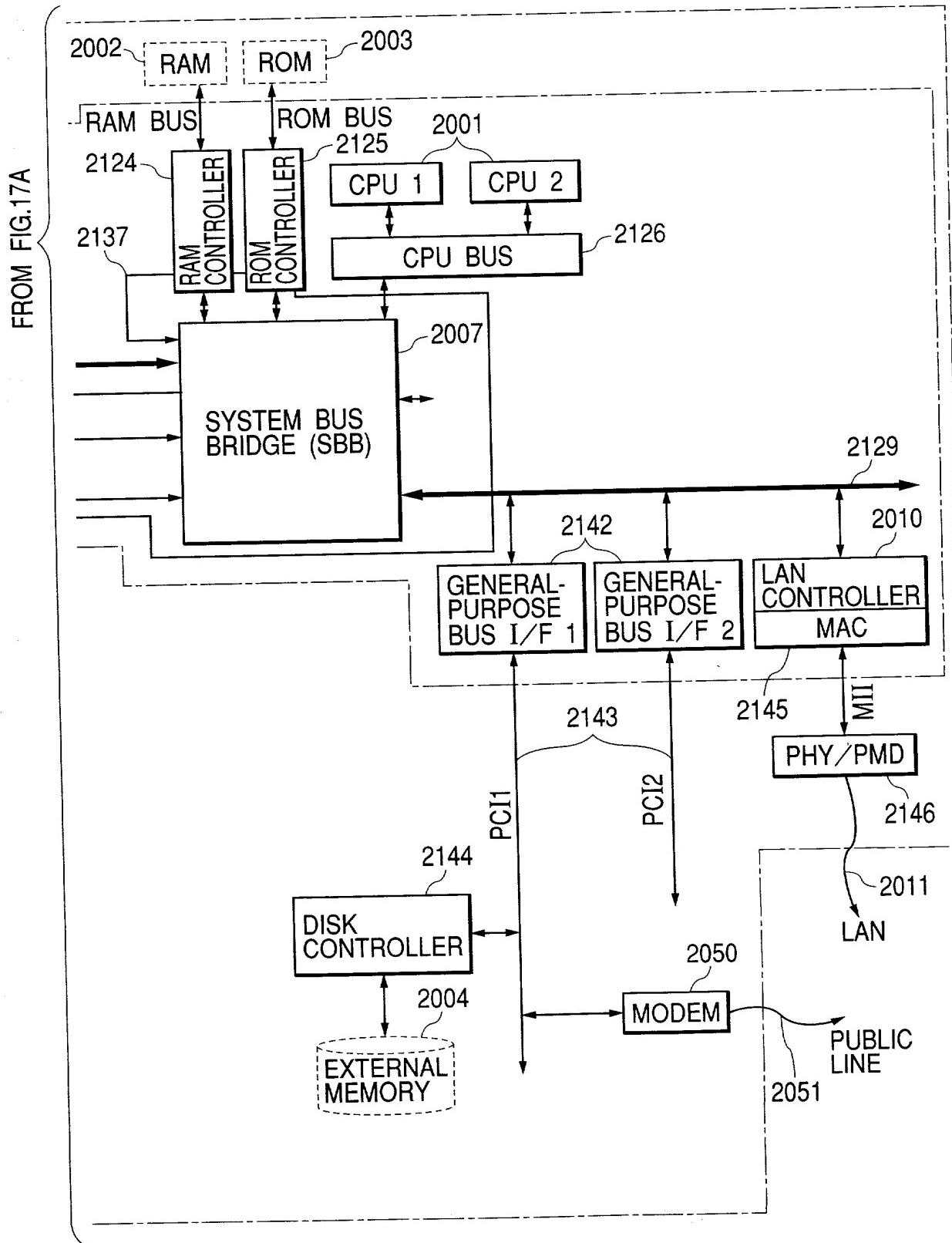


**FIG. 17**

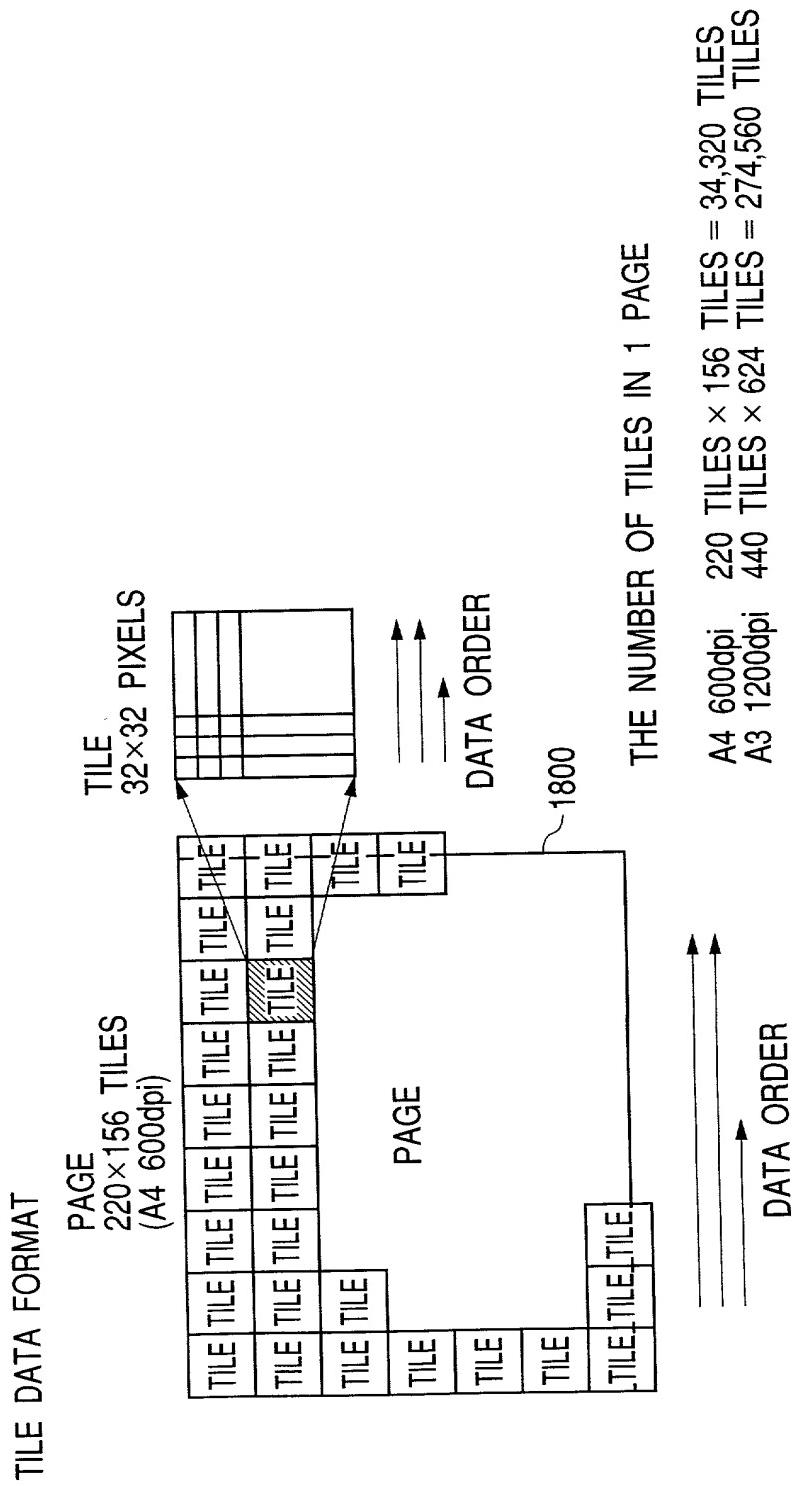
FIG. 17A FIG. 17B

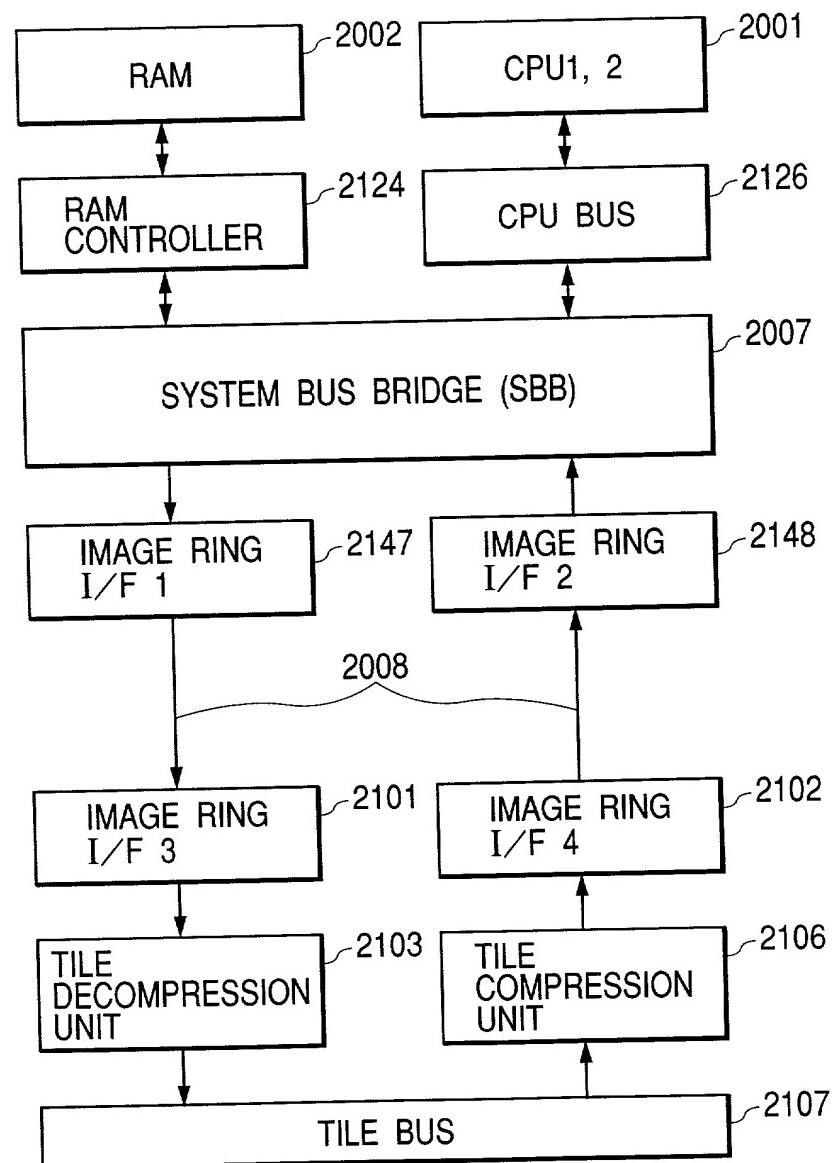
**FIG. 17A**

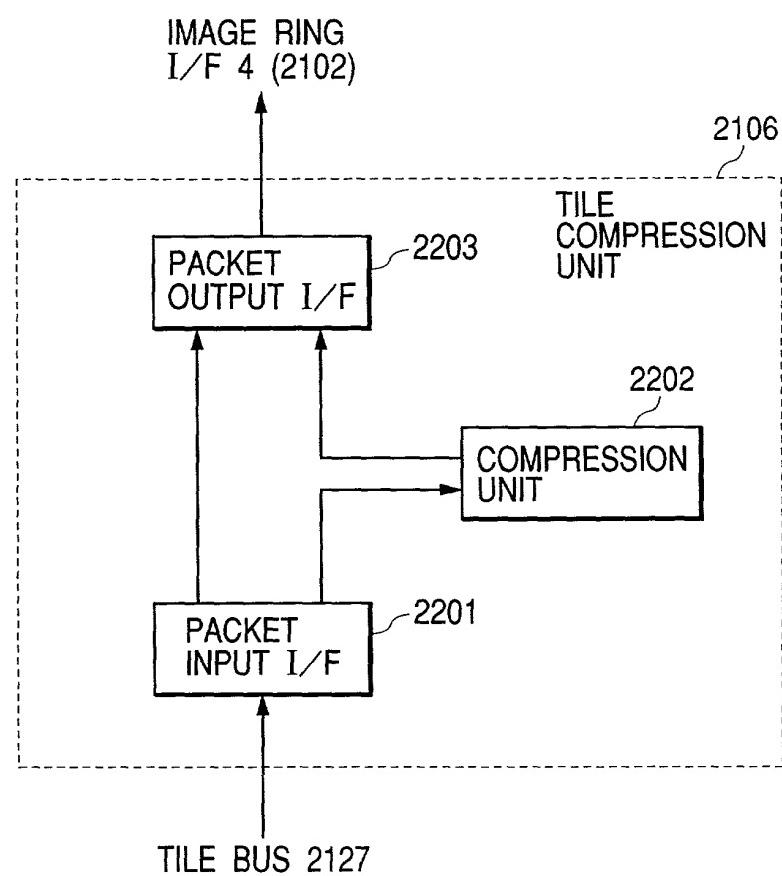
TO FIG.17B

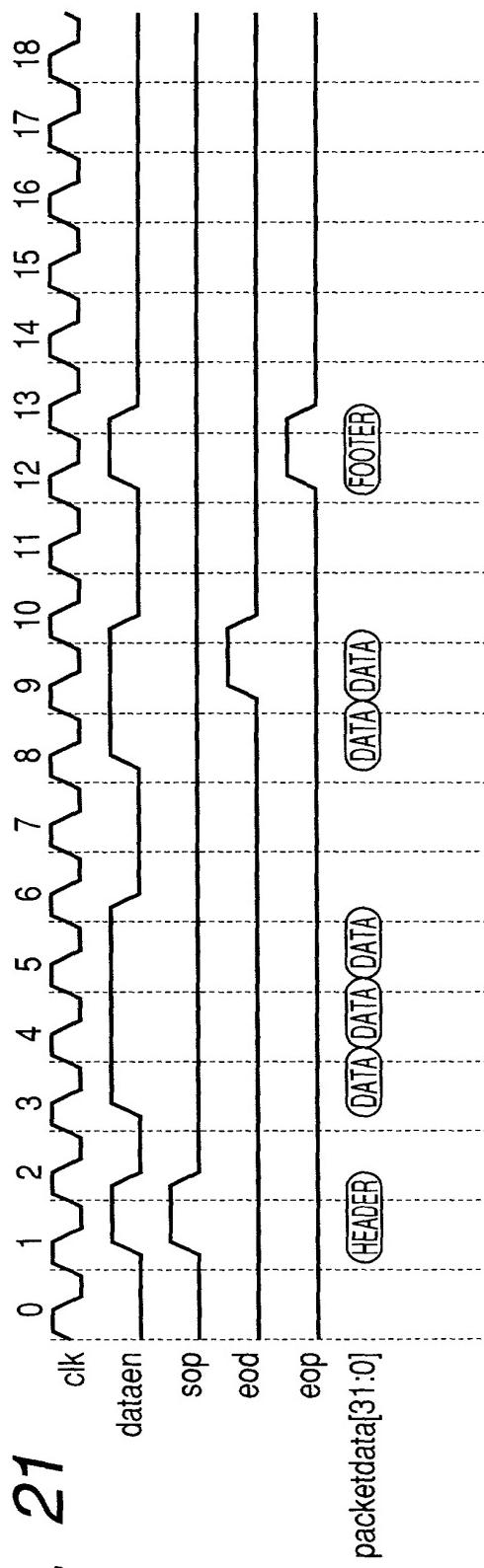
**FIG. 17B**

*FIG. 18*



**FIG. 19**

**FIG. 20**

**FIG. 21****FIG. 22**